

High Current, Power Inductors

HCP0605 Series







Description

- Halogen free
- 125°C maximum total temperature operation
- 5.3 x 6.1 x 4.95mm surface mount package
- · Powder Iron core material
- · High current carrying capacity, high permeability
- Frequency range up to 1MHz
- · RoHS compliant

Applications

- Voltage Regulator Module (VRM)
- Multi-phase regulators
- · Desktop and server VRMs and EVRDs
- Point of load modules
- Notebook regulators
- · Data networking and storage systems
- Graphics cards
- Battery power systems

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (with derated current)
- Solder reflow temperature: J-STD-020D compliant

Packaging

 Supplied in tape and reel packaging, 1,000 parts per reel, 13" diameter reel

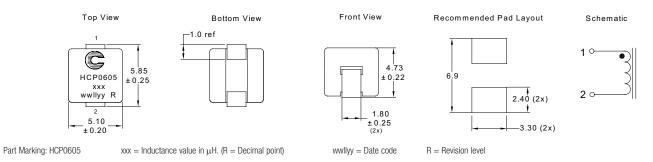
| | Product Specifications | | | | | |
|---------------|------------------------|------------------|-------------------|-------------------|-------------|-----------|
| | OCL1 | FLL ² | I _{rms³} | I _{sat⁴} | DCR mΩ@20°C | |
| Part Number⁵ | μH ± 15% | μΗ Minimum | Amps | Amps@25°C | Maximum | K-factor⁴ |
| HCP0605-R10-R | 0.095 | 0.06 | 53 | 20 | 0.40 | 120.5 |

- 1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0Adc
- 2 Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1V_{rms}, I_{sat}
- 2 For Local moderates (LEZ) restrictions to story 2.5 For Philist, 3at 1 Irms: DC current for an approximate ΔT rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.
- 4 I_{sat}: Peak current for approximately 30% rolloff at 25°C.
- 5 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I_{,} B_{p-p}$: (Gauss), K: (K-factor from table), L: (inductance in μ H), ΔI (peak-to-peak ripple current in amps).
- 6 Part Number Definition: HCP0605-xxx-R
 - HCP0605 = Product code and size
 - xxx= Inductance value in μ H, R = decimal point.
 - "-R" suffix = RoHS compliant

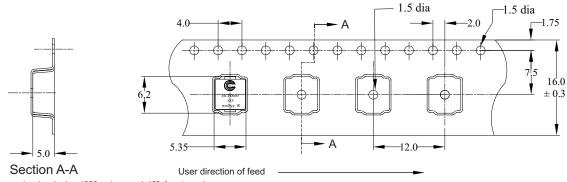
0609 BU09494 Page 1 of 4 Data Sheet: 4368 **COOPER Bussmann**



Dimensions - mm

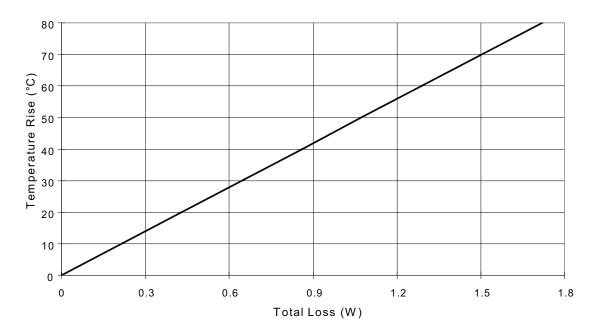


Packaging Information - mm



Supplied in tape-and-reel packaging, 1000 parts per reel, 13" diameter reel.

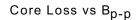
Temperature Rise vs. Total Loss

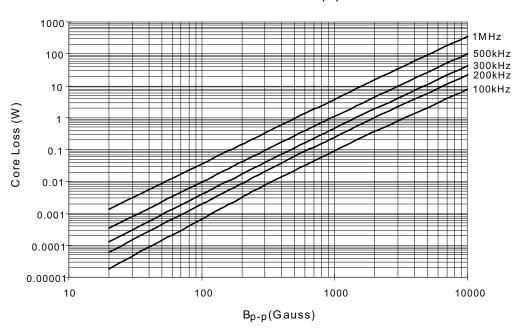


0609 BU09494 Page 2 of 4 Data Sheet: 4368 **COOPER Bussmann**



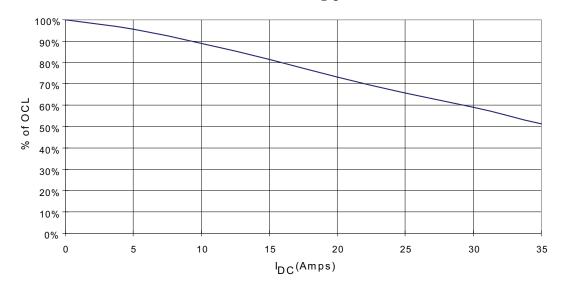
Core Loss





inductance Characteristics

% of OCL vs I_{DC}



0609 BU09494 Page 3 of 4 Data Sheet: 4368 **COOPER Bussmann**



Solder Reflow Profile

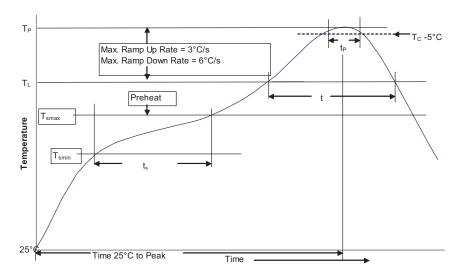


Table 1 - Standard SnPb Solder (T_C)

| Package Thickness | Volume mm³ <350 | Volume mm³ ≥350 |
|----------------------|-----------------------|-----------------------|
| <2.5mm | 235°C | 220°C |
| ≥2.5mm | 220°C | 220°C |

Table 2 - Lead (Pb) Free Solder (Tc)

| | Volume | Volume | Volume |
|-------------|--------|------------|--------|
| Package | mm³ | mm³ | mm³ |
| Thickness | <350 | 350 - 2000 | >2000 |
| <1.6mm | 260°C | 260°C | 260°C |
| 1.6 - 2.5mm | 260°C | 250°C | 245°C |
| >2.5mm | 250°C | 245°C | 245°C |

Reference JDEC J-STD-020D

| Profile Feature | 0.12 0.20 | Standard SnPb Solder | Lead (Pb) Free Solder 150°C | |
|---|--|-------------------------|--------------------------------|--|
| Preheat and Soak | • Temperature min. (T _{smin}) | 100°C | | |
| | Temperature max. (T _{smax}) | 150°C | 200°C | |
| | Time (T _{smin} to T _{smax}) (t _s) | 60-120 Seconds | 60-120 Seconds | |
| Average ramp up rat | te T _{smax} to T _p | 3°C/ Second Max. | 3°C/ Second Max. | |
| Liquidous temperature (TL) Time at liquidous (tL) | | 183°C 60-150 Seconds | 217°C 60-150 Seconds | |
| Peak package body temperature (Tp)* | | Table 1 | Table 2 | |
| Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c) | | 20 Seconds** | 30 Seconds** | |
| Average ramp-down rate (T _p to T _{smax}) | | 6°C/ Second Max. | 6°C/ Second Max. | |
| Time 25°C to Peak Temperature | | 6 Minutes Max. | 8 Minutes Max. | |

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

North America Cooper Electronic Technologies 1225 Broken Sound Parkway NW Boca Raton, FL 33487-3533 Tel: 1-561-998-4100 Fax: 1-561-241-6640 Toll Free: 1-888-414-2645

Cooper Bussmann P.O. Box 14460 St. Louis, MO 63178-4460 Tel: 1-636-394-2877 Fax: 1-636-527-1607

EuropeCooper Electronic Technologies Cooper (UK) Limited Burton-on-the-Wolds Leicestershire • LE12 5TH UK Tel: +44 (0) 1509 882 737 Fax: +44 (0) 1509 882 786

Cooper Electronic Technologies Avda. Santa Eulalia, 290 08223

Terrassa, (Barcelona), Spain Tel: +34 937 362 812 +34 937 362 813 Fax: +34 937 362 719

Asia Pacific

Cooper Electronic Technologies 1 Jalan Kilang Timor #06-01 Pacific Tech Centre Singapore 159303 Tel: +65 278 6151 Fax: +65 270 4160

The only controlled copy of this Data Sheet is the electronic read-only version located on the Cooper Bussmann Network Drive. All other copies of this document are by definition uncontrolled. This bulletin is intended to clearly present comprehensive product data and provide technical information that will help the end user with design applications. Cooper Bussmann reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Cooper Bussmann also reserves the right to change or update, without notice, any technical information contained in this bulletin. Once a product has been selected, it should be tested by the user in all possible applications.

Life Support Policy: Cooper Bussmann does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

© 2009 Cooper Bussmann St. Louis, MO 63178 www.cooperbussmann.com







Data Sheet: 4368



^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.